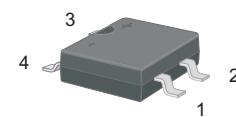


3A SURFACE MOUNT SCHOTTKY BRIDGE
FEATURES:

- Reverse Voltage - 40 to 200 V
- Forward Current - 3 A
- High Surge Current Capability
- Designed for Surface Mount Application

PINNING

PIN	DESCRIPTION
1	Input Pin (~)
2	Input Pin (~)
3	Output Anode (+)
4	Output Cathode (-)


MBS Package
MECHANICAL DATA

- Case: MBS
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 100mg / 0.0035oz

Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MB34S	MB36S	MB38S	MB310S	MB320S	Units						
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	40	60	80	100	200	V						
Maximum RMS voltage	V_{RMS}	28	42	56	70	140	V						
Maximum DC Blocking Voltage	V_{DC}	40	60	80	100	200	V						
Maximum Average Forward Rectified Current at $T_c = 100^\circ\text{C}$	$I_{F(AV)}$	3.0					A						
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	80		70			A						
Max Instantaneous Forward Voltage at 3 A	V_F	0.55	0.70	0.85		0.95	V						
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 100^\circ\text{C}$	I_R	0.5 10	0.3 5				mA						
Typical Junction Capacitance ¹⁾	C_j	250	160				pF						
Typical Thermal Resistance ²⁾	$R_{\theta JA}$	65					°C/W						
Operating Junction Temperature Range	T_j	-55 ~ +150					°C						
Storage Temperature Range	T_{stg}	-55 ~ +150					°C						

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

MB34S THRU MB320S

Fig.1 Forward Current Derating Curve

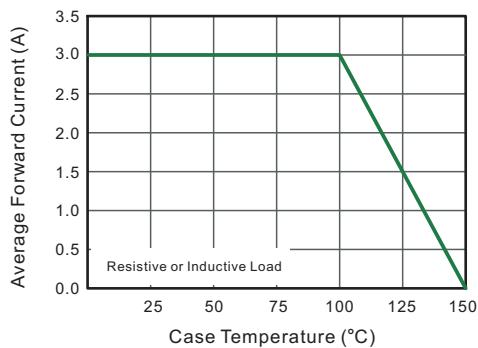


Fig.2 Typical Reverse Characteristics

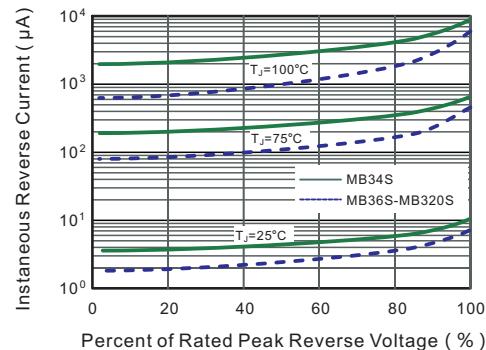


Fig.3 Typical Forward Characteristic

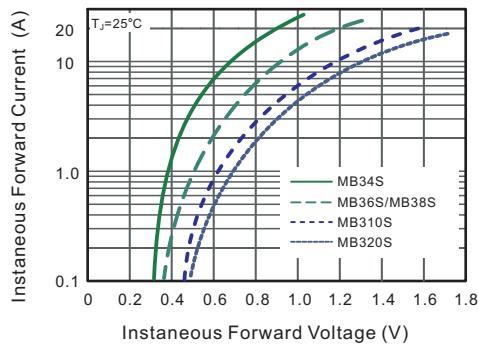


Fig.4 Typical Junction Capacitance

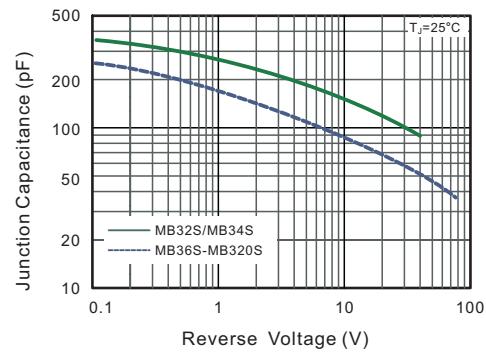


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

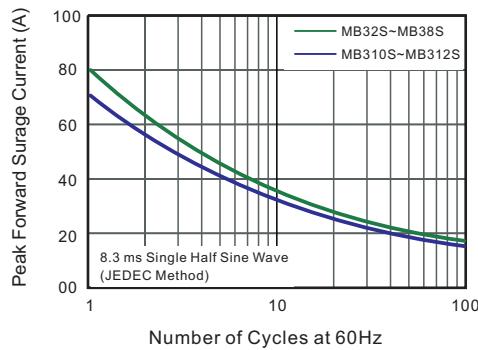
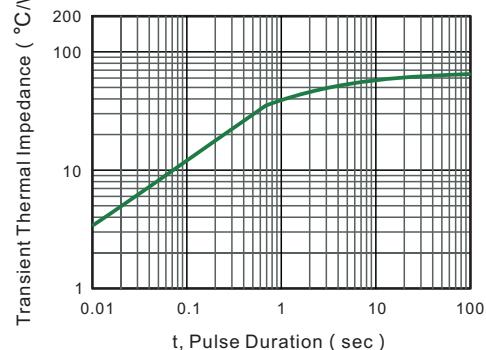


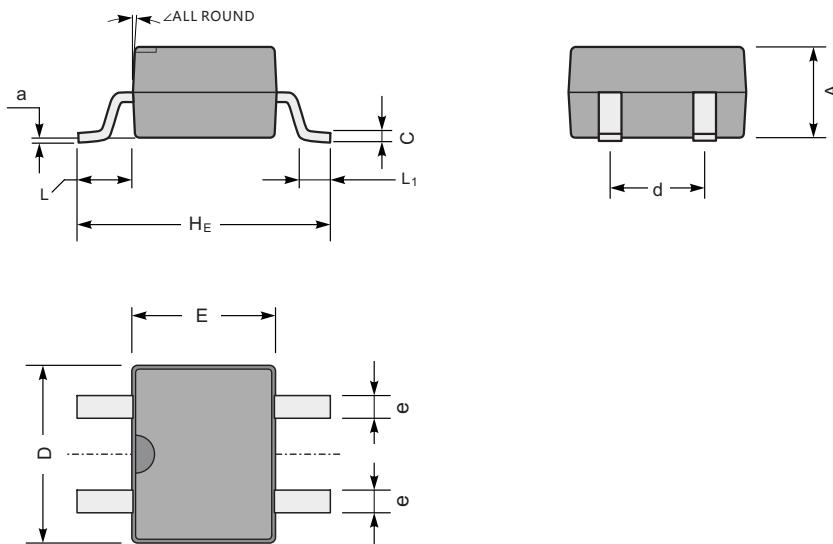
Fig.6 Typical Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

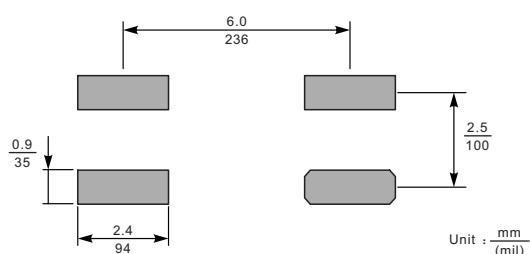
MBS



MBS mechanical data

UNIT		A	C	D	E	H_E	d	e	L	L_1	a	\angle
mm	max	2.6	0.22	5.0	4.1	7.0	2.7	0.7	1.7	1.1	0.2	7°
	min	2.2	0.15	4.5	3.6	6.4	2.3	0.5	1.3	0.5	—	
mil	max	102	8.7	197	161	276	106	28	67	43	8	7°
	min	94	5.9	177	142	252	91	20	51	20	—	

The recommended mounting pad size



Marking

Type number	Marking code
MB34S	MB34S
MB36S	MB36S
MB38S	MB38S
MB310S	MB310S
MB320S	MB320S

